



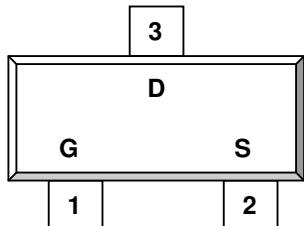
ST2302 Pb
N Channel Enhancement Mode MOSFET

3.6A

DESCRIPTION

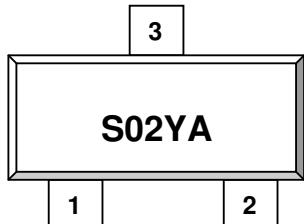
ST2302 is the N-Channel logic enhancement mode power field effect transistor which is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management, other battery powered circuits, and low in-line power loss are required. The product is in a very small outline surface mount package.

PIN CONFIGURATION SOT-23



1.Gate 2.Source 3.Drain

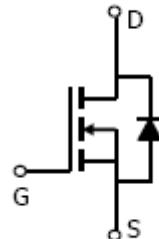
PART MARKING SOT-23



Y: Year Code A: Process Code

FEATURE

- 20V/3.6A, $R_{DS(ON)} = 70\text{m}\Omega$ @VGS = 4.5V
- 20V/3.1A, $R_{DS(ON)} = 95\text{ m}\Omega$ @VGS = 2.5V
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23 package design



ORDERING INFORMATION

Part Number	Package	Part Marking
ST2302	SOT-23	S02YA

* Process Code : A ~ Z ; a ~ z

STANSON TECHNOLOGY
120 Bentley Square, Mountain View, Ca 94040 USA
www.stansontech.com

ST2302 2005. V1



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ABSOLUTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	20	V
Gate-Source Voltage	V _{GSS}	±12	V
Continuous Drain Current(TJ=150°C)	I _D	3.6 2.6	A
Pulsed Drain Current	I _{DM}	10	A
Continuous Source Current (Diode Conduction)	I _S	1.6	A
Power Dissipation	P _D	1.25 0.8	W
Operation Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	100	°C/W



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ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

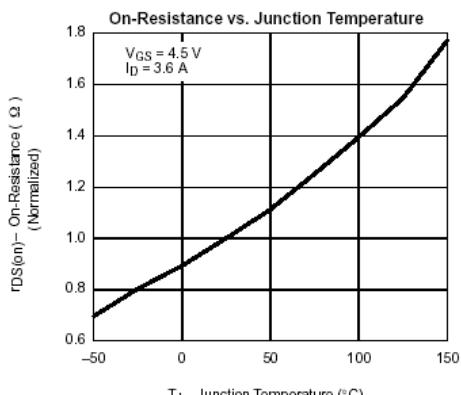
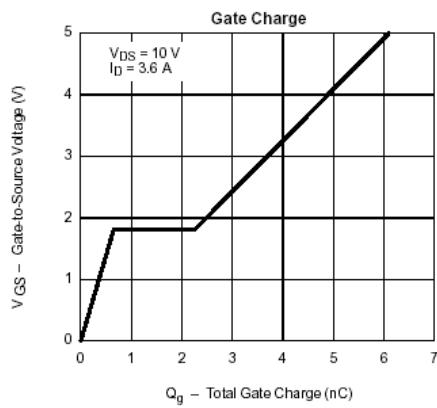
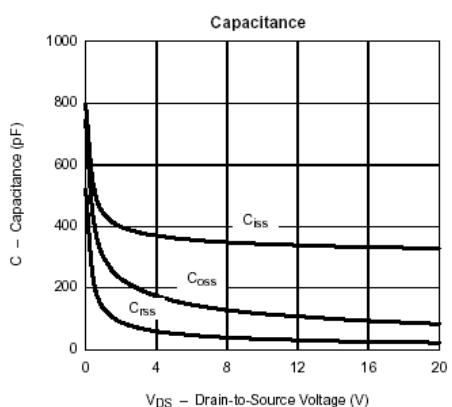
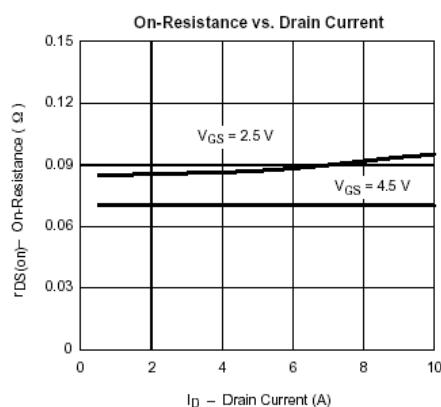
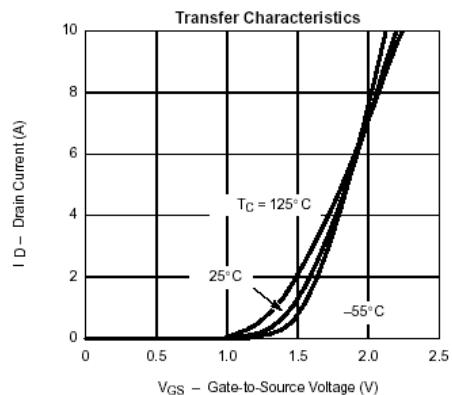
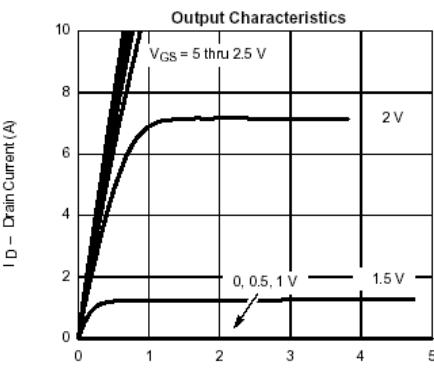
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250uA	20			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	0.4		1.0	V
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±12V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V			1	uA
		V _{DS} =20V, V _{GS} =0V T _J =55°C			10	
Drain-source On-Resistance	R _{D(S(on))}	V _{GS} =4.5V, I _D =3.6A V _{GS} =2.5V, I _D =3.1A		0.070 0.095		Ω
Forward Transconductance	g _{fs}	V _{DS} =5V, I _D =3.6V		10		S
Diode Forward Voltage	V _{SD}	I _S =1.6A, V _{GS} =0V		0.85	1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =10V V _{GS} =4.5V I _D ≡3.6A		5.4	10	nC
Gate-Source Charge	Q _{gs}			0.65		
Gate-Drain Charge	Q _{gd}			1.4		
Input Capacitance	C _{iss}	V _{DS} =10V V _{GS} =0V F=1MHz		340		pF
Output Capacitance	C _{oss}			115		
Reverse Transfer Capacitance	C _{rss}			33		
Turn-On Time	t _{d(on)} tr	V _{DD} =10V R _L =5.5Ω I _D =3.6A V _{GEN} =4.5V R _G =6Ω		12	25	nS
Turn-Off Time	t _{d(off)} tf			36	60	
				34	60	
				10	25	



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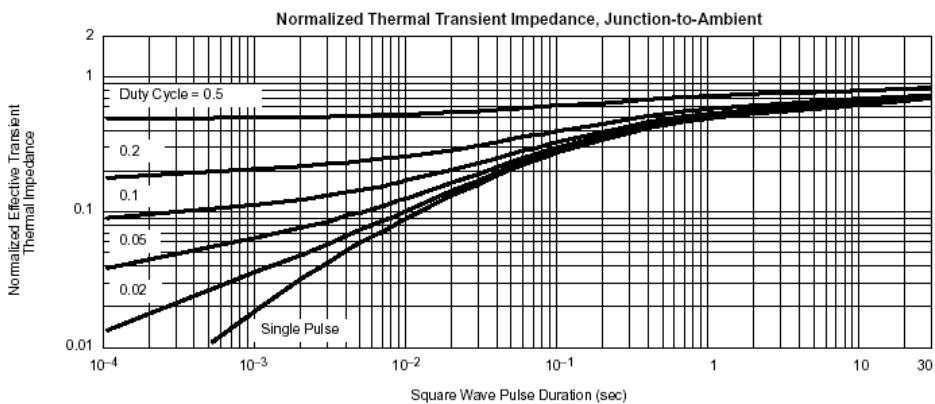
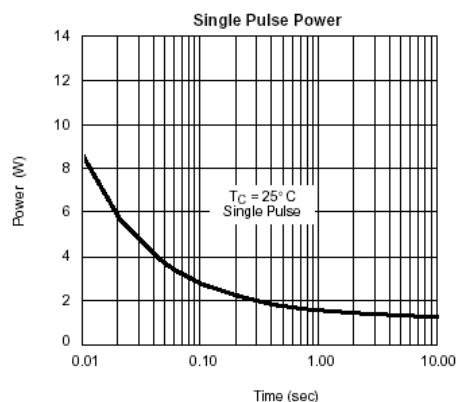
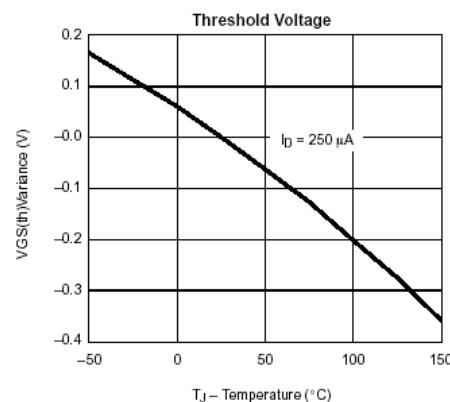
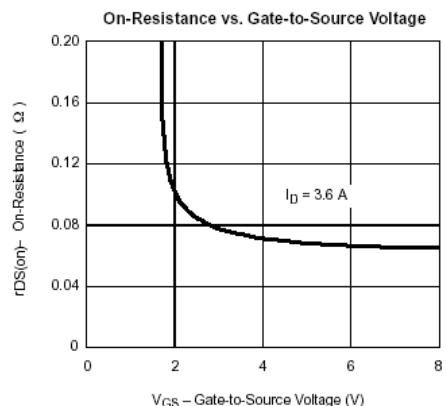
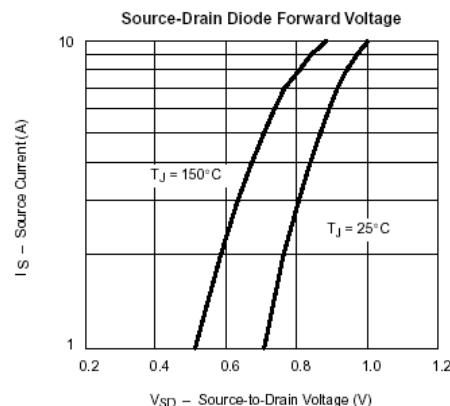




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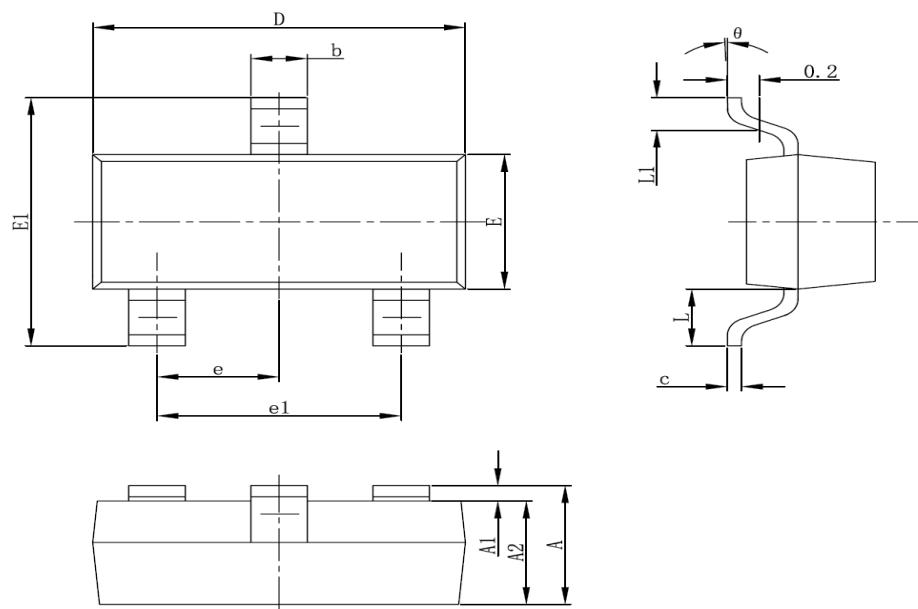
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SOT-23 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°